

Fast Switching EmCon Diode

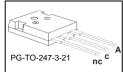
Features:

- 600 V EmCon technology
- Fast recovery
- Soft switching
- Low reverse recovery charge
- Low forward voltage
- 175 °C junction operating temperature
- Easy paralleling
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <u>http://www.infineon.com/emcon/</u>

Applications:

- Welding
- Motor drives





Туре	V _{RRM}	l _F	<i>V</i> _{F,<i>Tj</i>=25℃}	T _{j,max}	Marking	Package
IDW100E60	600V	100A	1.65V	175°C	D100E60	PG-TO-247-3-21

Maximum Ratings

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	V _{RRM}	600	V
Continuous forward current	I _F		А
$T_{\rm C} = 25^{\circ}{\rm C}$		150	
$T_{\rm C} = 90^{\circ}{\rm C}$		104	
$T_{\rm C} = 100^{\circ}{\rm C}$		96	
Surge non repetitive forward current	I _{FSM}	400	А
$T_{\rm C} = 25^{\circ}$ C, $t_{\rm p} = 10$ ms, sine halfwave			
Maximum repetitive forward current	I _{FRM}	300	А
$T_{\rm C}$ = 25°C, $t_{\rm p}$ limited by $t_{\rm j,max}$, D = 0.5			
Power dissipation	P _{tot}		W
$T_{\rm C} = 25^{\circ}{\rm C}$		375	
$T_{\rm C} = 90^{\circ}{\rm C}$		212	
$T_{\rm C} = 100^{\circ}{\rm C}$		198	
Operating junction and storage temperature	T _{j,} T _{stg}	-55+175	°C
Soldering temperature 1.6mm (0.063 in.) from case for 10 s	Ts	260	°C



Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	<u>_</u>			•
Thermal resistance,	R _{thJC}		0.40	K/W
junction – case				
Thermal resistance,	R _{thJA}		40	
junction - ambient				

Electrical Characteristic, at $T_j = 25$ °C, unless otherwise specified

Parameter	Symbol	Conditions		Value		Unit
	Symbol	Conditions	min.	typ.	max.	Onit

Static Characteristic

Collector-emitter breakdown voltage	V _{RRM}	I _R =0.25mA	600	-	-	V
Diode forward voltage	V _F	I _F =100A				Ī
		T _j =25°C	-	1.65	2.0	
		<i>T</i> _j =175°C	-	1.65	-	
Reverse leakage current	I _R	V _R =600V				μA
		T _j =25°C	-	-	40	
		<i>T</i> _j =175°C	-	-	1000	

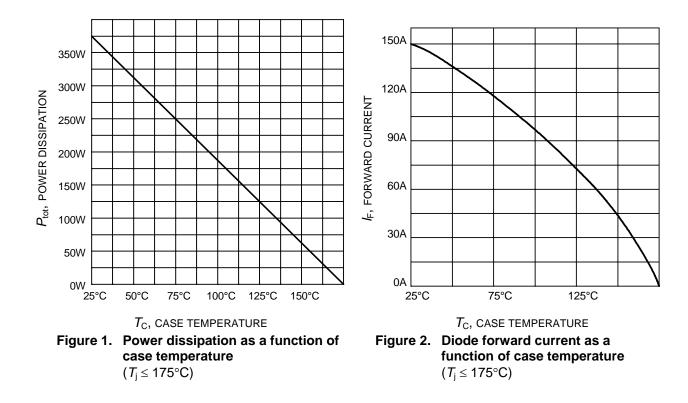
Dynamic Electrical Characteristics

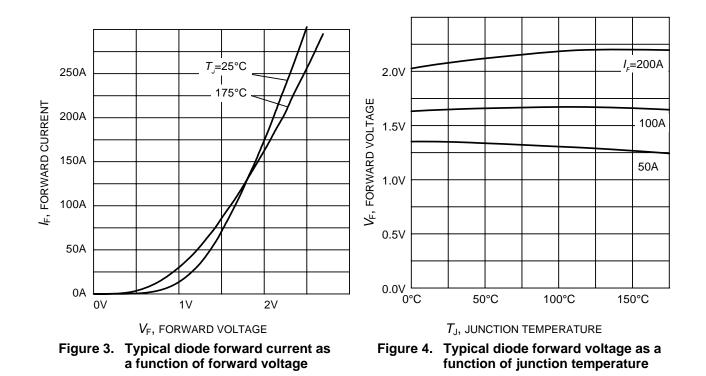
Diode reverse recovery time	t _{rr}	<i>T</i> _j =25°C	-	120	-	ns
Diode reverse recovery charge	Q _{rr}	V _R =400V,	-	3.6	-	μC
Diode peak reverse recovery current	I _{rr}	I _F =100A,	-	49.5	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	dI _{rr} /dt	dI _F /dt=1200A/µs	-	750	-	A/µs

Diode reverse recovery time	t _{rr}	<i>T</i> _j =125°C	-	168	-	ns
Diode reverse recovery charge	Q _{rrm}	V _R =400V,	-	5.8	-	μC
Diode peak reverse recovery current	I _{rr}	I _F =100A,	-	61.6	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	dI _{rr} /dt	dI _F /dt=1200A/µs	-	705	-	A/µs

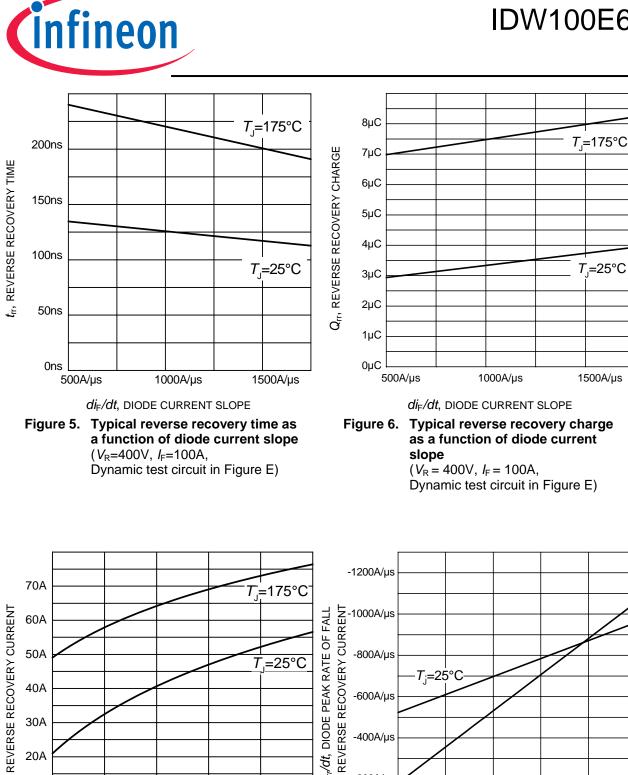
Diode reverse recovery time	t _{rr}	<i>T</i> _j =175°C	-	200	-	ns
Diode reverse recovery charge	Q _{rrm}	V _R =400V,	-	7.8	-	μC
Diode peak reverse recovery current	I _{rr}	I _F =100A,	-	67.0	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	dI _{rr} /dt	dI _F /dt=1200A/µs	-	650	-	A/µs

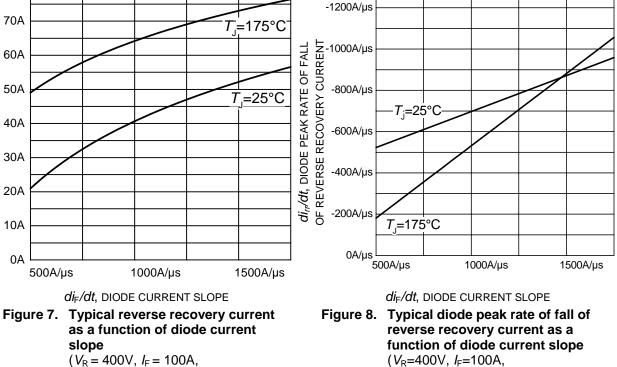






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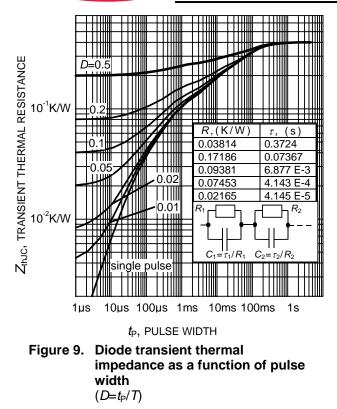
Dynamic test circuit in Figure E)

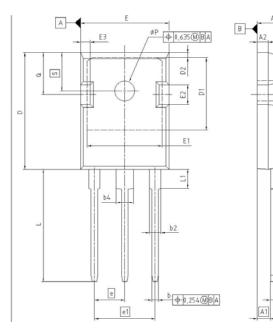
Dynamic test circuit in Figure E)

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IDW100E60







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DIM	MILLIMI	ETERS	INCI	HES
	MIN	MAX	MIN	MAX
Α	4.903	5.157	0.193	0.203
A1	2.273	2.527	0.092	0.096
A2	1.853	2.107	0.075	0.081
b	1.073	1.327	0.047	0.052
b2	1.903	2.386	0.075	0.094
b4	2.870	3.454	0.113	0.136
C	0.549	0.752	0.024	0.030
D	20.823	21.077	0.820	0.830
D1	17.323	17.831	0.682	0.702
D2	1.063	1.317	0.042	0.052
Е	15.773	16.027	0.621	0.631
E1	13.893	14.147	0.547	0.557
E2	3.683	3.937	0.145	0.155
E3	1.683	1.937	0.066	0.076
e	5.4	50	0.2	215
e1	10.9	00	0.4	130
N	3			3
La	20.053	20.307	0.789	0.799
L1	4.168	4.472	0.164	0.176
øP	3.559	3.661	0.140	0.144
Q	5.493	5.747	0.216	0.226
S	6.043	6.297	0.238	0.248



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